

## Technical Data Sheet

### Top View LEDs

#### 67-21/GBC-YV2W2N/2T

#### Features

- . P-LCC-2 package.
- . White package.
- . Optical indicator.
- . Colorless clear window.
- . Wide viewing angle.
- . Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- . Computable with automatic placement equipment.
- . Available on tape and reel (8mm Tape).
- . Pb-free
- . The product itself will remain within RoHS compliant version



#### Descriptions

- . The 67-21 series is available in soft orange, green, blue and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes TOP LED ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

#### Applications

- . Automotive: backlighting in dashboard and switch.
- . Telecommunication: indicator and backlighting in telephone and fax.
- . Flat backlight for LCD, switch and symbol.
- . Light pipe application.
- . General use.

#### Device Selection Guide

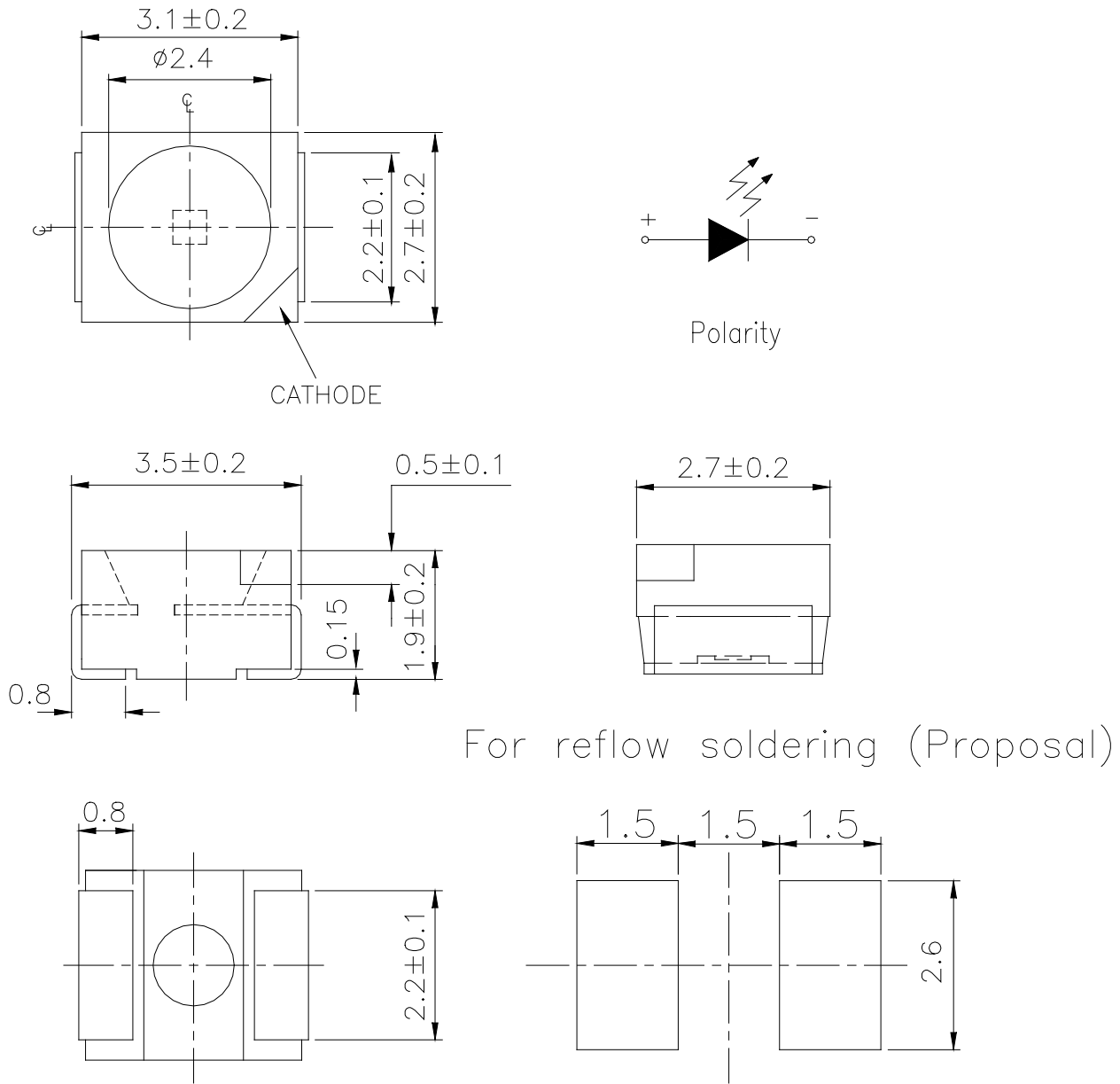
Chip	Emitted Color	Resin Color
Material		
InGaN	Brilliant Green	Water Clear

**Technical Data Sheet**

**Top View LEDs**

**67-21/GBC-YV2W2N/2T**

**Package Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm ;Unit = mm

**Technical Data Sheet**
**Top View LEDs**
**67-21/GBC-YV2W2N/2T**
**Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	V <sub>R</sub>	5	V
Forward Current	I <sub>F</sub>	30	mA
Peak Forward Current (Duty 1/10 @ 1KHz)	I <sub>FP</sub>	100	mA
Power Dissipation	P <sub>d</sub>	110	mW
Electrostatic Discharge (HBM)	ESD	1000	V
Operating Temperature	T <sub>opr</sub>	-40 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +90	°C
Soldering Temperature	T <sub>sol</sub>	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.	

**Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I <sub>v</sub>	900	-----	1800	mcd	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>	-----	120	-----	deg	I <sub>F</sub> =20mA
Peak Wavelength	λ <sub>p</sub>	-----	518	-----	nm	I <sub>F</sub> =20mA
Dominant Wavelength	λ <sub>d</sub>	520	-----	535	nm	I <sub>F</sub> =20mA
Spectrum Radiation Bandwidth	Δλ	-----	35	-----	nm	I <sub>F</sub> =20mA
Forward Voltage	V <sub>F</sub>	2.70	-----	3.70	V	I <sub>F</sub> =20mA
Reverse Current	I <sub>R</sub>	-----	-----	50	μA	V <sub>R</sub> =5V

**Notes:**

- 1.Tolerance of Luminous Intensity : ±11%
- 2.Tolerance of Dominant Wavelength : ±1nm
- 3.Tolerance of Forward Voltage : ±0.1V

## Technical Data Sheet

### Top View LEDs

**67-21/GBC-YV2W2N/2T**

#### Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
V2	900	1120	mcd	I <sub>F</sub> =20mA
W1	1120	1420		
W2	1420	1800		

#### Bin Range of Dominant Wavelength

Group	Bin Code	Min.	Max.	Unit	Condition
Y	X	520	525	nm	I <sub>F</sub> =20mA
	Y	525	530		
	Z	530	535		

#### Bin Range of Forward Voltage

Group	Bin Code	Min.	Max.	Unit	Condition
N	10	2.70	2.90	V	I <sub>F</sub> =20mA
	11	2.90	3.10		
	12	3.10	3.30		
	13	3.30	3.50		
	14	3.50	3.70		

#### Notes:

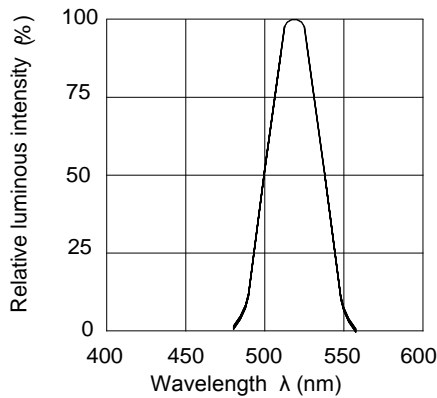
- 1.Tolerance of Luminous Intensity :  $\pm 11\%$
- 2.Tolerance of Dominant Wavelength :  $\pm 1\text{nm}$
- 3.Tolerance of Forward Voltage :  $\pm 0.1\text{V}$

**Technical Data Sheet**  
**Top View LEDs**

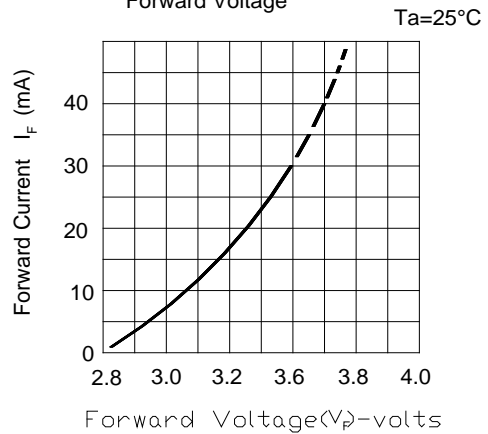
**67-21/GBC-YV2W2N/2T**

**Typical Electro-Optical Characteristics**

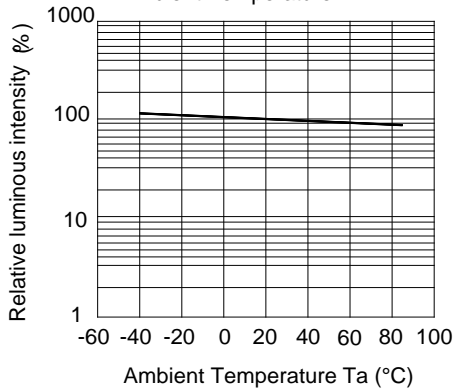
Spectrum Distribution



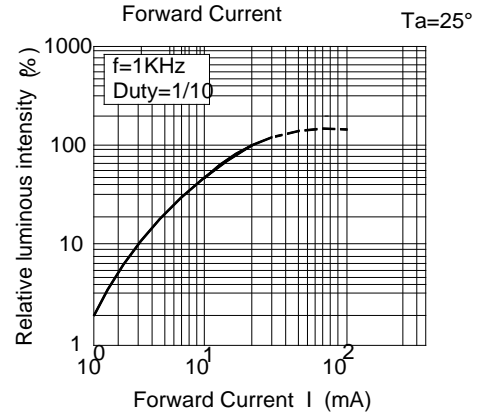
Forward Current vs. Forward Voltage



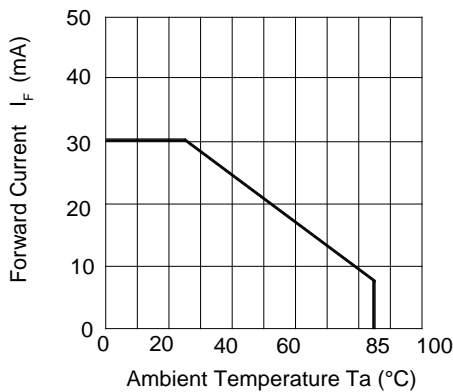
Relative Luminous Intensity vs. Ambient Temperature



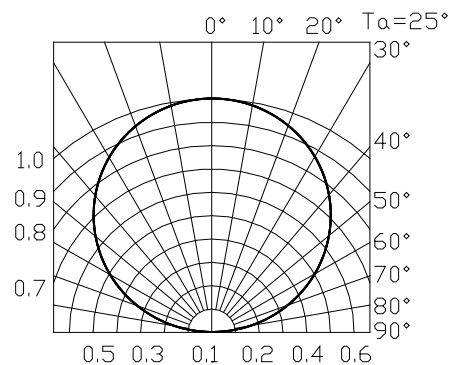
Relative Luminous Intensity vs Forward Current



Forward Current Derating Curve



Radiation Diagram



**Technical Data Sheet**  
**Top View LEDs**

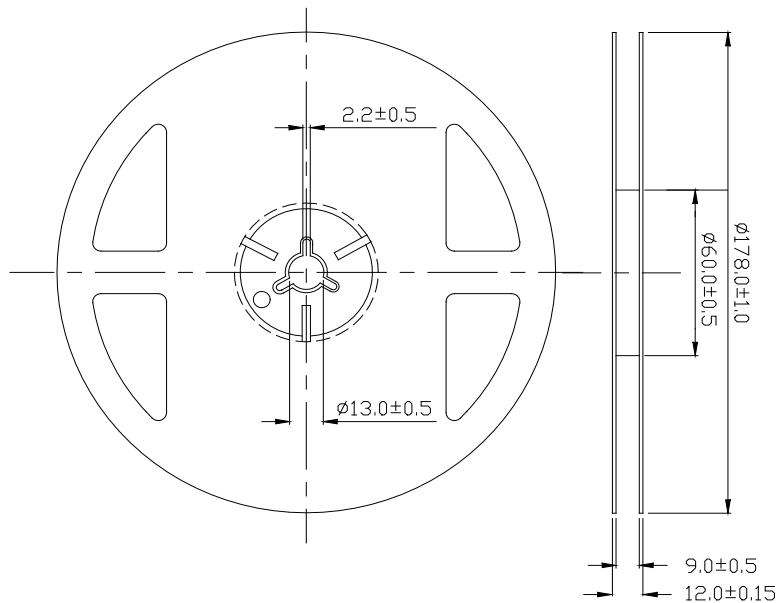
**67-21/GBC-YV2W2N/2T**

**Label Explanation**

CAT: Luminous Intensity Rank  
HUE: Dom. Wavelength Rank  
REF: Forward Voltage Rank



**Reel Dimensions**



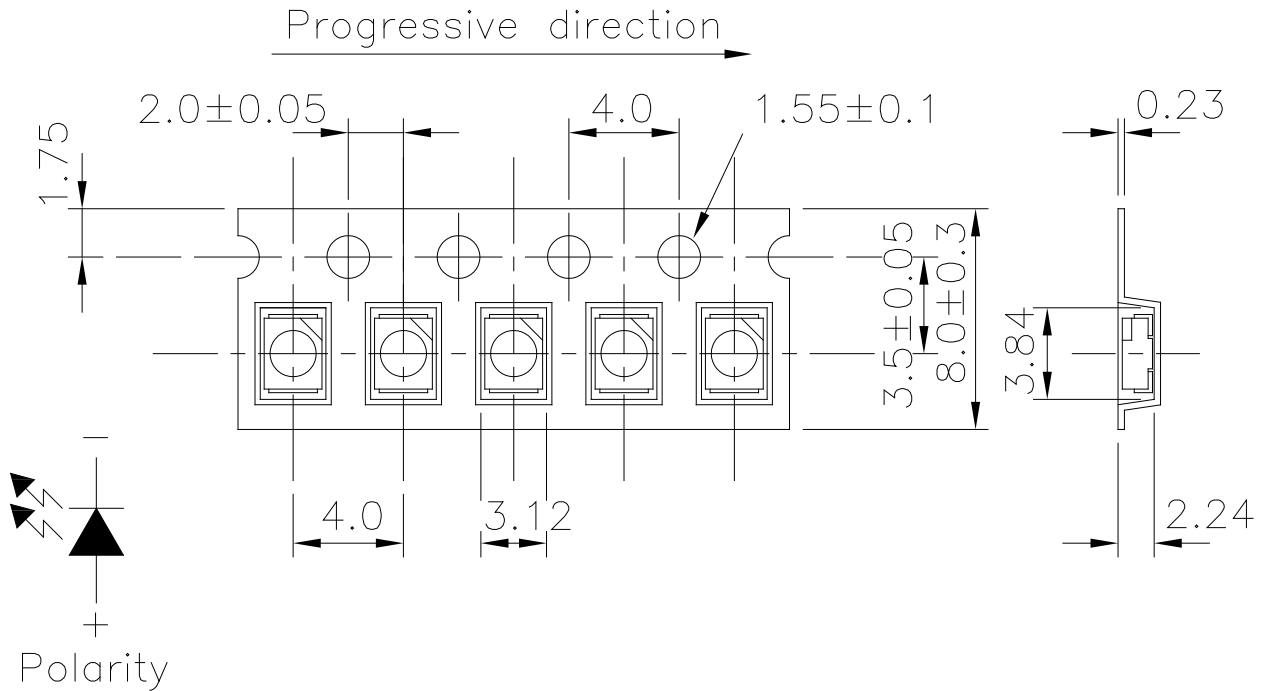
**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm ,Unit = mm

**Technical Data Sheet**

**Top View LEDs**

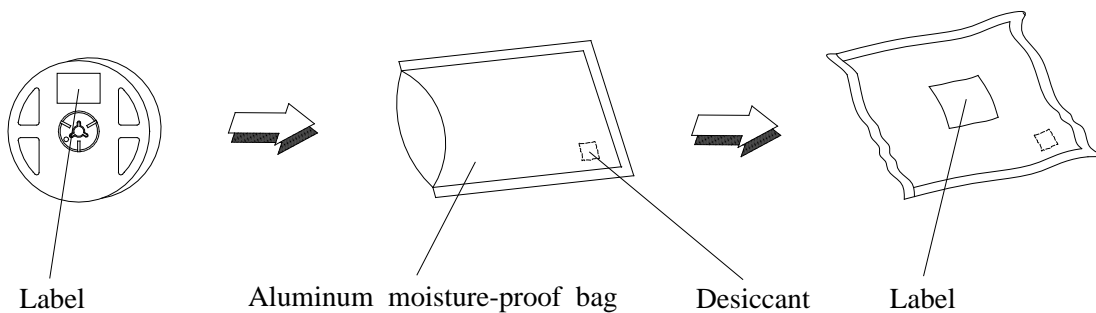
**67-21/GBC-YV2W2N/2T**

**Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel.**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm; Unit = mm

**Moisture Resistant Packaging**



## Technical Data Sheet

### Top View LEDs

#### 67-21/GBC-YV2W2N/2T

#### Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H : +100°C 15min ↓ 5 min L : -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H : +100°C 5min ↓ 10 sec L : -10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	I <sub>F</sub> = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1



## Technical Data Sheet

### Top View LEDs

**67-21/GBC-YV2W2N/2T**

#### Precautions for Use

##### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

##### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

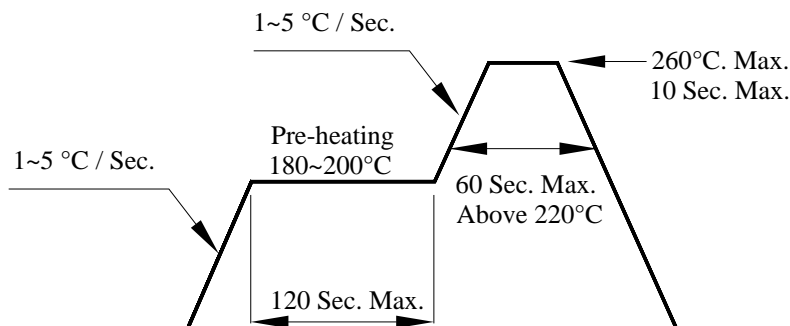
2.3 After opening the package: The LED's floor life are 168 hours under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

##### 3. Soldering Condition

##### 3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

## Technical Data Sheet

### Top View LEDs

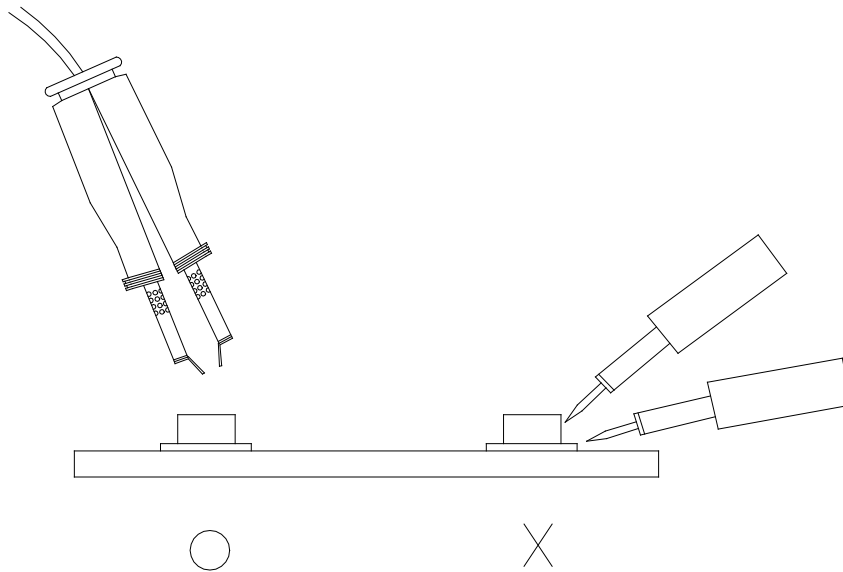
#### 67-21/GBC-YV2W2N/2T

#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



**EVERLIGHT ELECTRONICS CO., LTD.**  
Office: No 25, Lane 76, Sec 3, Chung Yang Rd,  
Tucheng, Taipei 236, Taiwan, R.O.C

Tel: 886-2-2267-2000, 2267-9936  
Fax: 886-2267-6244, 2267-6189, 2267-6306  
<http://www.everlight.com>